

600V N-Channel Power MOSFET



SOT-223

1 2 3

Pin Definition:

- 1. Gate
- 2. Drain
- 3. Source

PRODUCT SUMMARY

V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)
600	5 @ V _{GS} =10V	0.6

General Description

The TSM2N60S is used an advanced termination scheme to provide enhanced voltage-blocking capability without degrading performance over time. In addition, this advanced MOSFET is designed to withstand high energy in avalanche and commutation modes. The new energy efficient design also offers a drain- to-source diode with a fast recovery time. Designed for high voltage, high speed switching applications in power supplies, converters and PWM motor controls, these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional and safety margin against unexpected voltage transients.

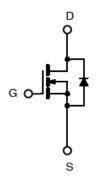
Features

- Robust high voltage termination
- Avalanche energy specified
- Diode is characterized for use in bridge circuits
- Source to Drain diode recovery time comparable to a discrete fast recovery diode.

Ordering Information

Part No.	Package	Packing
TSM2N60SCW RP	SOT-223	2.5Kpcs / 13" Reel

Block Diagram



N-Channel MOSFET

Absolute Maximum Rating (Ta = 25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	600	V
Gate-Source Voltage	V_{GS}	±30	V
Continuous Drain Current	I _D	0.6	Α
Pulsed Drain Current	I _{DM}	1.5	Α
Continuous Source Current (Diode Conduction)	I _S	1	Α
Drain Source Voltage Slope ($V_{DS} = 480V$, $I_D = 0.8A$, $T_J = 125$ °C)	dv/dt	50	V/ns
Total Maximum Power Dissipation @Ta = 25°C	P _{DTOT}	2.5	W
Operating Junction Temperature	T _J	+150	°C
Operating Junction and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Thermal Performance

Parameter	Symbol	Limit	Unit
Thermal Resistance - Junction to Case	$R\Theta_{JC}$	15	°C/W
Thermal Resistance - Junction to Ambient	R⊖ _{JA}	55.8	°C/W

Notes: Surface mounted on FR4 board t ≤ 10sec

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Electrical Specifications (Ta = 25°C unless otherwise noted)

Parameter	Conditions	Symbol	Min	Тур	Max	Unit
Static						
Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	BV _{DSS}	600			V
Drain-Source On-State Resistance	$V_{GS} = 10V, I_D = 0.6A$	R _{DS(ON)}		3.6	5	Ω
Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250uA$	$V_{GS(TH)}$	2		4	V
Zero Gate Voltage Drain Current	V _{DS} =600V, V _{GS} =0V	I _{DSS}			1	uA
Gate Body Leakage	V_{GS} =±30V, V_{DS} =0V	I _{GSS}			±100	nA
Forward Transconductance	$V_{DS} = 10V, I_{D} = 0.2A$	g _{fs}		8.0		S
Diode Forward Voltage	I _S =0.6A, V _{GS} =0V	V_{SD}		0.85	1.15	V
Dynamic ^b						
Total Gate Charge	\/ -400\/ I -0.6A	Q_g		13		
Gate-Source Charge	$V_{DS} = 400V, I_D = 0.6A,$	Q_{gs}		2		nC
Gate-Drain Charge	V _{GS} = 10V	Q_{gd}		6		
Input Capacitance	V _{DS} =25V, V _{GS} =0V, f =1.0MHz	C _{iss}		435		
Output Capacitance		C _{oss}		56		pF
Reverse Transfer Capacitance		C _{rss}		9.2		
Switching ^c						
Turn-On Delay Time		t _{d(on)}		12		
Turn-On Rise Time	$V_{GS} = 10V, I_D = 0.6A,$	t _r		21		nS
Turn-Off Delay Time	$V_{DD} = 300 V, R_G = 18 \Omega$	t _{d(off)}		30] 113
Turn-Off Fall Time		t _f		24		

Notes:

- a. Pulse test: pulse width <=300uS, duty cycle <=2%
- b. For design reference only, not subject to production testing.
- c. Switching time is essentially independent of operating temperature.

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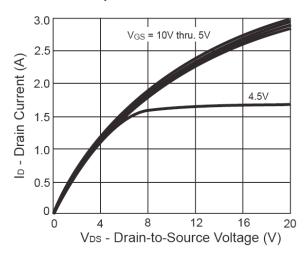


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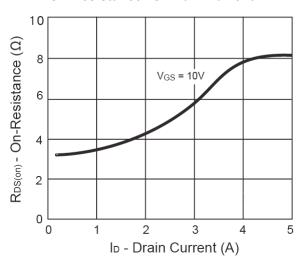


Electrical Characteristics Curve (Ta = 25°C, unless otherwise noted)

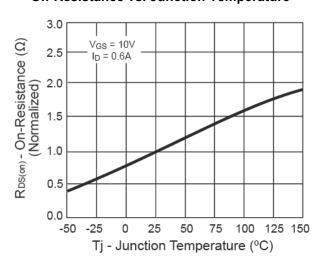
Output Characteristics



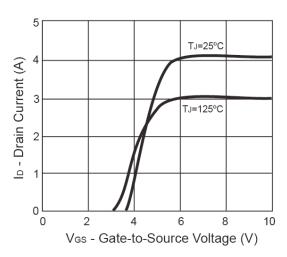
On-Resistance vs. Drain Current



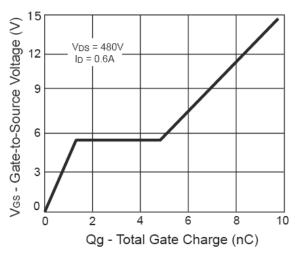
On-Resistance vs. Junction Temperature



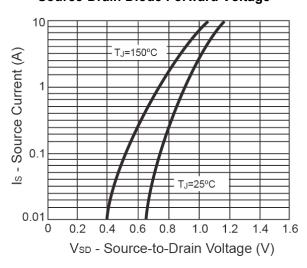
Transfer Characteristics



Gate Charge



Source-Drain Diode Forward Voltage



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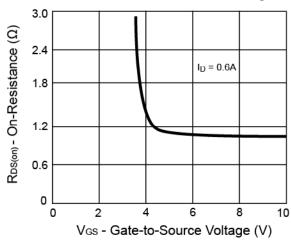


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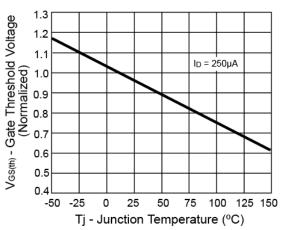


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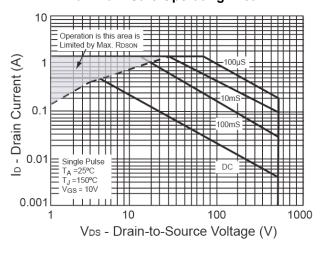
On-Resistance vs. Gate-Source Voltage



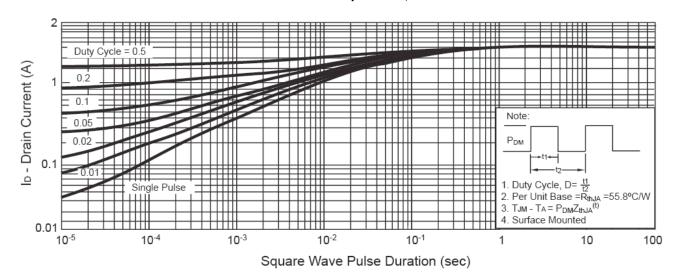
Threshold Voltage



Maximum Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



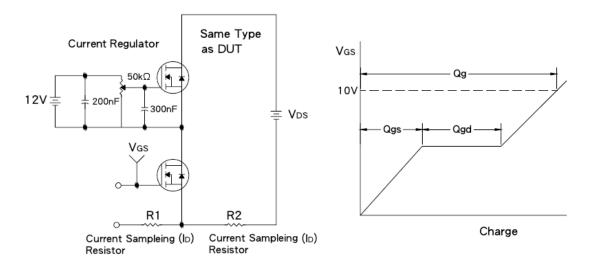
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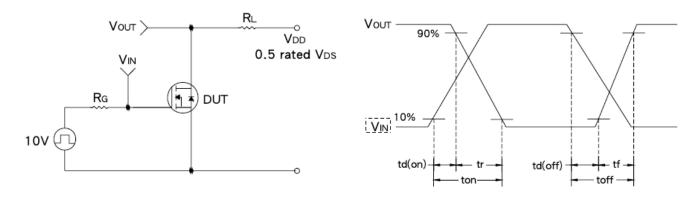
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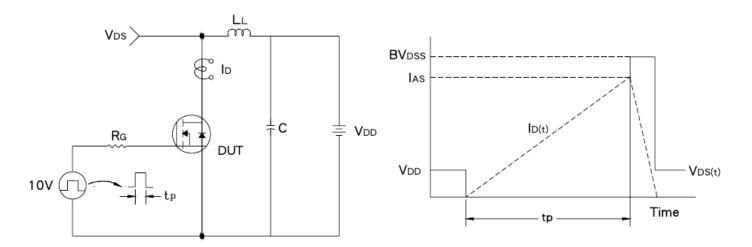
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



EAS Test Circuit & Waveform



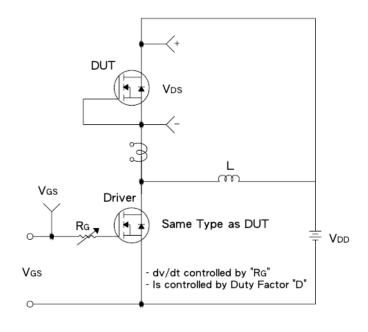
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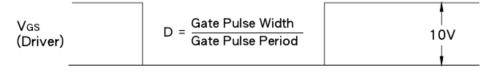


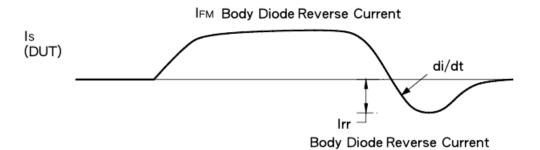
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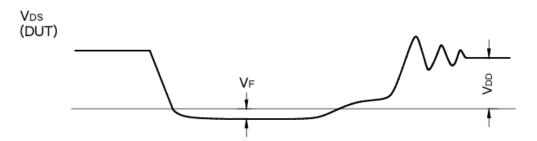


Diode Reverse Recovery Time Test Circuit & Waveform









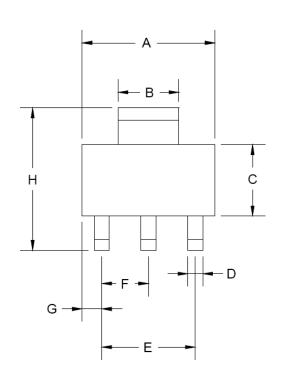
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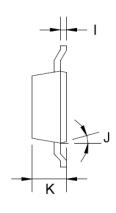


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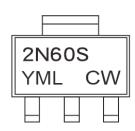
SOT-223 Mechanical Drawing





	SOT-223 DIMENSION						
DIM	MILLIMETERS		INCHES				
DIIVI	MIN	MAX	MIN	MAX			
Α	6.350	6.850	0.250	0.270			
В	2.900	3.100	0.114	0.122			
С	3.450	3.750	0.136	0.148			
D	0.595	0.635	0.023	0.025			
Е	4.550	4.650	0.179	0.183			
F	2.250	2.350	0.088	0.093			
G	0.835	1.035	0.032	0.041			
Н	6.700	7.300	0.263	0.287			
I	0.250	0.355	0.010	0.014			
J	10°	16°	10°	16°			
K	1.550	1.800	0.061	0.071			

Marking Diagram



Y = Year Code

M = Month Code

(A=Jan, B=Feb, C=Mar, D=Apl, E=May, F=Jun, G=Jul, H=Aug, I=Sep,

J=Oct, K=Nov, L=Dec)

L = Lot Code

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